

Vishay Semiconductors

Insulated Ultrafast Rectifier Module, 60 A



FEATURES

- Two fully independent diodes
- Ceramic fully insulated package (V_{ISOL} = 2500 V_{AC})



- Ultrafast reverse recovery
- Ultrasoft reverse recovery current shape
- Low forward voltage
- Optimized for power conversion: welding and industrial SMPS applications
- Industry standard outline
- Plug-in compatible with other SOT-227 packages
- Easy to assemble
- Direct mounting to heatsink
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

DESCRIPTION

The UFB60FA60P insulated modules integrate two state of the art Vishay Semiconductors ultrafast recovery rectifiers in the compact, industry standard SOT-227 package. The planar structure of the diodes, and the platinum doping life time control, provide an ultrasoft recovery current shape, together with the best overall performance, ruggedness, and reliability characteristics.

These devices are thus intended for high frequency applications in which the switching energy is designed not to be a predominant portion of the total energy, such as in the output rectification stage of welding machines, SMPS, and DC/DC converters. Their extremely optimized stored charge and low recovery current reduce both over dissipation in the switching elements (and snubbers) and EMI/RFI.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	V _R		600	V	
Continuous forward current per diode	١ _F	T _C = 85 °C	44	А	
Single pulse forward current per diode	I _{FSM}	T _C = 25 °C	280		
Maximum power dissipation per module	PD	T _C = 85 °C	120	W	
RMS isolation voltage	VISOL	Any terminal to case, t = 1 min	2500	V	
Operating junction and storage temperatures	T _J , T _{Stg}		- 55 to 175	°C	

VR 600 V IF(AV) per module at T_C = 107 °C 60 A t_{rr} 79 ns

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	I _R = 100 μA		600	-	-	
		I _F = 30 A		-	1.32	1.69	v
Forward voltage	V	I _F = 60 A		-	1.52	1.9	
Forward voltage	V _{FM}	I _F = 30 A	T _J = 125 °C	-	1.14	1.39	
		I _F = 60 A		-	1.38	1.66	
		$V_R = V_R$ rated		-	0.1	100	μA
Reverse leakage current	I _{RM}	$T_J = 175 \text{ °C}, V_R = V_R \text{ rated}$		-	0.2	1.0	mA
Junction capacitance	CT	V _R = 600 V - 50		50	-	pF	

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
	t _{rr}	T _J = 25 °C	I _F = 30 A dI _F /dt = 200 A/μs V _R = 200 V	-	79	118	- ns
Reverse recovery time		T _J = 125 °C		-	155	209	
Deck see a s	I _{RRM}	T _J = 25 °C		-	6	10	A
Peak recovery current		T _J = 125 °C		-	14	20	
Reverse recovery charge	Q _{rr}	T _J = 25 °C		-	234	590	nC
		T _J = 125 °C		-	1085	2090	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction to case, single leg conducting	В		-	-	1.5	
Junction to case, both leg conducting	– R _{thJC}		-	-	0.75	°C/W
Case to heatsink	R _{thCS}	Flat, greased surface	-	0.05	-	
Weight			-	30	-	g
Mounting torque			-	1.3	-	N·m

Not Available for New Designs, Use VS-UFB80FA60



UFB60FA60P

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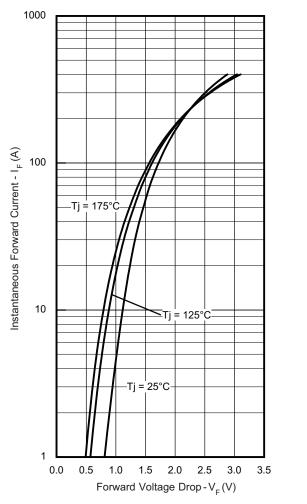


Fig. 1 - Typical Forward Voltage Drop Characteristics (Per Diode)

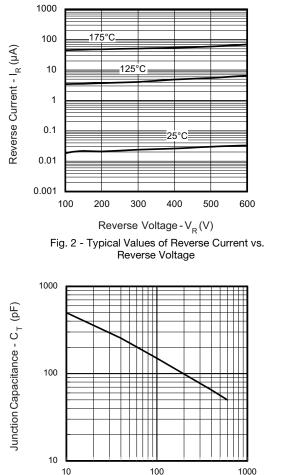
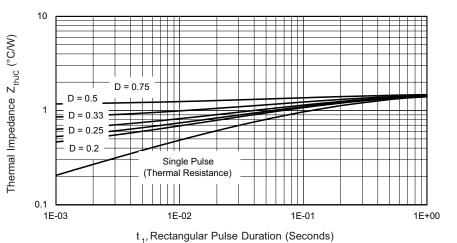
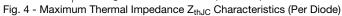




Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage





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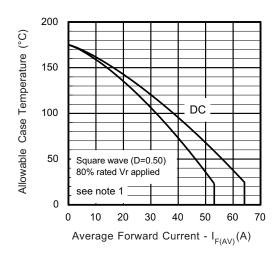


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

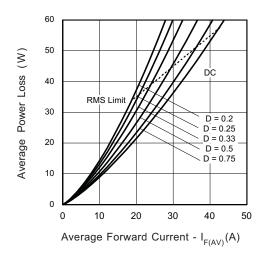


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} =$ Inverse power loss = $V_{R1} \times I_R$ (1 - D); I_R at $V_{R1} =$ 80 % rated V_R

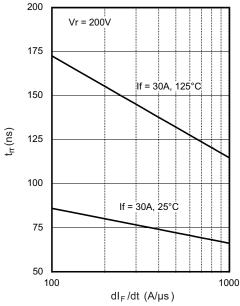
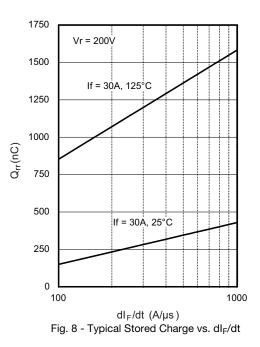


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt







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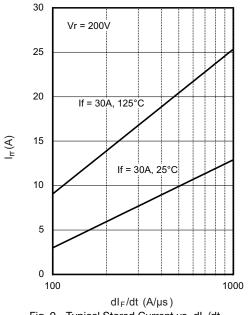


Fig. 9 - Typical Stored Current vs. dl_F/dt

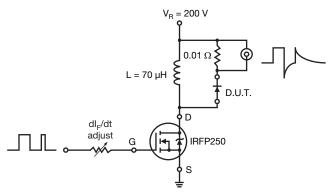


Fig. 10 - Reverse Recovery Parameter Test Circuit

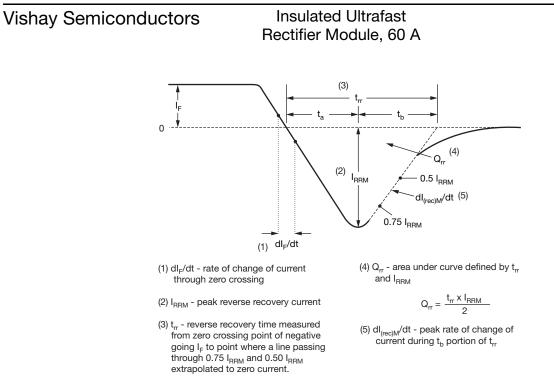
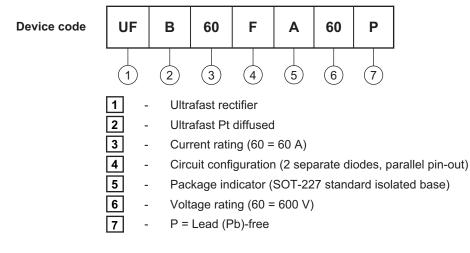
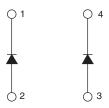


Fig. 11 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE



CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?95036					
Packaging information	www.vishay.com/doc?95037				

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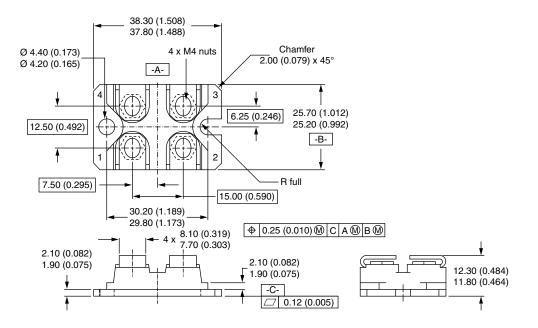


Outline Dimensions

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SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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